Current report no. 14/2018

Date of issue: 2018-03-12

Abbreviated name of the Issuer: DEKPOL S.A.

Subject: Early redemption and remission of a part of D-series bonds

Legal basis: Article 17 Section 1 MAR (Market Abuse Regulation) – inside information.

Content of report:

Following current report no. 60/2015 dated 2nd of October 2015 and current report no. 62/2015 dated 19th of October 2015 concerning D-series bonds issue programme ("Bonds"), Management Board of DEKPOL S.A. ("Issuer") announces, that on 12th of March 2018 adopted resolution about early partial redemption of Bonds. The subject of early redemption will be 223 751 Bonds of a joint nominal value in the amount of PLN 22.375.100 described by code ISIN PLDEKPL00065. Early redemption of Bonds will follow on the basis of point 18 of Bonds Issue Conditions with the purpose of its remission.

The Issuer will perform early partial redemption of Bonds as at interests payout for the tenth interest period, i.e. on 16th of April 2018, paying Bondholders for each Bond the amount equal to its nominal value underlying early redemption (i.e. PLN 100,00 for each bond), outstanding interests for tenth interest period in full amount, as well as bonus in the amount of 0,25% of nominal value of bonds underlying early partial redemption. In connection with the above mentioned, from 4th of April 2018 to 16th of April 2018 will follow suspension of a trade turnover of Bonds on ASO BondSpot and ASO GPW, while the 6th of April 2018 has been appointed as a day of arrangement of entities entitled to the above mentioned remission.

At the same time, as of today, Management Board of the Issuer adopted resolution about remission of 45 049 Bonds described by code ISIN PLDEKPL00065 purchased by the Company on the basis of sales agreement of bonds on the OTC market with the bondholder in accordance with article 76 of the Act of Bonds. Joint nominal value of redeemed Bonds amounted PLN 4.504.900, while separate purchase price amounted PLN 101,05.

The purpose of early redemption and remission of Bonds is refinancing of a debt of the Company by use of G-series bonds, what has been notified in current report no. 11/2018 dated 7th of March 2018.